

Negative Voltage Regulators

■ GENERAL DESCRIPTION

The XC62K series are highly precise, low power consumption, negative voltage regulators, manufactured using CMOS and laser trimming technologies. The series achieves high output currents with small input-output voltage differentials, and consists of a high precision voltage reference, an error correction circuit, and an output driver with current limitation. SOT-23 (150mW), SOT-89 (500mW), USP-6B (100mW) and TO-92 (300mW) packages are available.

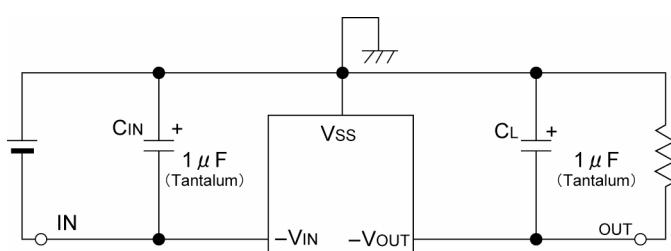
■ APPLICATIONS

- Battery powered equipment
- Portable & cellular phones
- Various portable equipment
- Power supply for GaAs applications

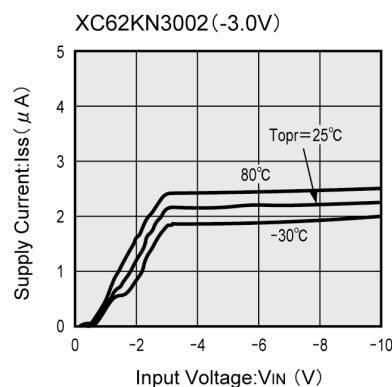
■ FEATURES

- Dropout Voltage** : 0.12V@50mA ($V_{OUT}=-5.0V$)
: 0.38V@100mA
- Maximum Output Current** : 100mA (within MAX. power dissipation, $V_{OUT} = -5.0V$)
- Output Voltage Range** : -2.1V ~ -6.0V in 100mV increments
-5.0, -4.0, -3.0V, -2.5V standard
(All other voltages are semi-custom)
- Highly Accurate** : Setting output voltage $\pm 2\%$
($\pm 1\%$ for semi-custom products)
- Low Power Consumption** : $3.0 \mu A$ @ $V_{OUT} = -5.0V$ (TYP.)
- Output Voltage Temperature Characteristics**
: $\pm 100ppm/\text{°C}$ (TYP.)
- Line Regulation** : 0.1%/V (TYP.)
- CMOS Low Power Consumption**
- Ultra Small Packages** : SOT-23 (150mW) mini-mold,
SOT-89 (500mW) mini-power mold
TO-92 (300mW)
USP-6B (100mV)

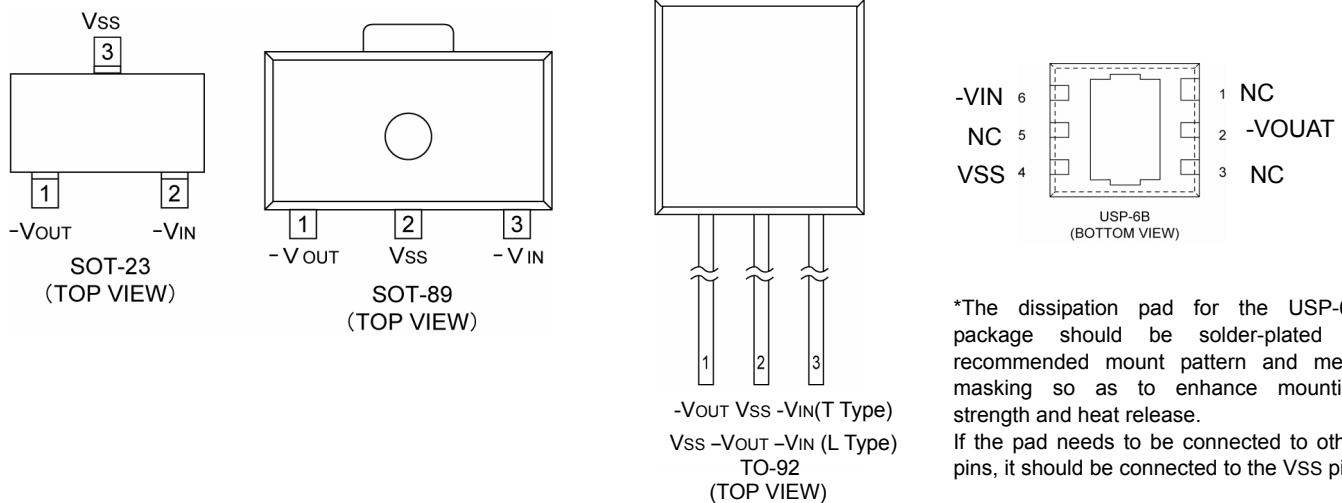
■ TYPICAL APPLICATION CIRCUIT



■ TYPICAL PERFORMANCE CHARACTERISTICS



■PIN CONFIGURATION



*The dissipation pad for the USP-6B package should be solder-plated in recommended mount pattern and metal masking so as to enhance mounting strength and heat release.
If the pad needs to be connected to other pins, it should be connected to the VSS pin.

■PIN ASSIGNMENT

PIN NUMBER				PIN NAME	FUNCTION
SOT-23	SOT-89/TO-92 (T)	TO-92 (L)	USP-6B		
2	3	3	6	-VIN	Power Supply Input
3	2	1	4	Vss	Ground
1	1	2	2	-VOUT	Output
—	—	—	1.3.5	NC	No Connection

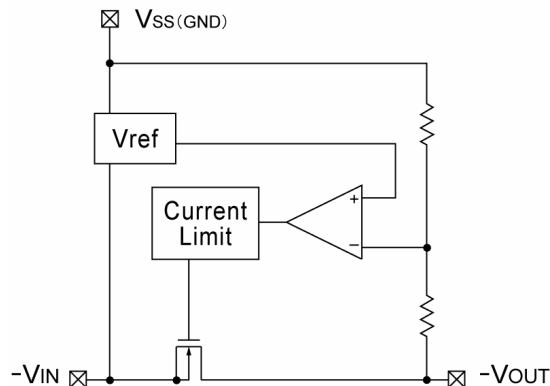
■PRODUCT CLASSIFICATION

● Ordering Information

XC62K①②③④⑤⑥⑦

MARK	DESCRIPTION	SYMBOL	DESCRIPTION
①	Polarity of Output Voltage	N	: Negative
② ③	Output Voltage	21 ~ 60	: e.g. VOUT – 2.1V → ②=2, ③=1 VOUT – 6.0V → ②=6, ③=0
④	Temperature Characteristics	0	: $\pm 100\text{ppm}$ (TYP.)
⑤	Output Voltage Accuracy	1	: $\pm 1\%$ (Semi-custom)
		2	: $\pm 2\%$
⑥	Package	M	: SOT-23
		P	: SOT-89
		T	: TO-92 (Standard)
		L	: TO-92 (Custom pin configuration)
		D	: USP-6B
⑦	Device Orientation	R	: Embossed tape, standard feed
		L	: Embossed tape, reverse feed
		H	: Paper type (TO-92)
		B	: Bag (TO-92)

■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS

Ta=25°C

PARAMETER	SYMBOL	RATINGS	UNITS
Input Voltage	VIN	-12.0	V
Output Current	IOUT	200	mA
Output Voltage	VOUT	-VDD-0.3~VIN+0.3	V
Power Dissipation	SOT-23	150	mW
	SOT-89	500	
	TO-92	300	
	USP-6B	100	
Operating Temperature Range	Topr	-30 ~ +80	°C
Storage Temperature Range	Tstg	-40 ~ +125	°C

Note: Please ensure that IOUT is less than Pd/(VOUT-VIN).

■ ELECTRICAL CHARACTERISTICS

XC62KN5002

V_{OUT(T)}=-5.0V

T_a=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage (*2)	V _{OUT(E)}	I _{OUT} =20mA V _{IN} =-6.0V	x 0.98 -4.90	V _{OUT(T)} -5.00	x 1.02 -5.10	V	2
Maximum Output Current	I _{OUT} max	V _{IN} =-6.0V, V _{OUT(E)} ≥-4.5V	100	-	-	mA	4
Load Regulation	ΔV _{OUT}	V _{IN} =6.0V 1mA≤I _{OUT} ≤50mA	-	40	80	mV	4
Dropout Voltage (*3)	V _{dif}	I _{OUT} =50mA	-	120	300	mV	3
		I _{OUT} =100mA	-	380	600		
Supply Current	I _{SS}	V _{IN} =-6.0V	-	3.0	7.0	μA	1
Line Regulation	ΔV _{OUT} ΔV _{IN} · V _{OUT}	I _{OUT} =20mA -6.0V≤V _{IN} ≤-10.0V	-	0.1	0.3	%V	3
Input Voltage	V _{IN}	-	-	-	-10.0	V	-
Output Voltage Temperature Characteristics	ΔV _{OUT} ΔV _{IN} · V _{OUT}	I _{OUT} =20mA -30°C≤T _{opr} ≤80°C	-	±100	-	ppm/ °C	-

XC62KN4002

V_{OUT(T)}=-4.0V

T_a=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage (*2)	V _{OUT(E)}	I _{OUT} =20mA V _{IN} =-5.0V	x 0.98 -3.92	V _{OUT(T)} -4.00	x 1.02 -4.08	V	2
Maximum Output Current	I _{OUT} max	V _{IN} =-5.0V, V _{OUT(E)} ≥-3.6V	80	-	-	mA	4
Load Regulation	ΔV _{OUT}	V _{IN} =-5.0V 1mA≤I _{OUT} ≤45mA	-	40	80	mV	4
Dropout Voltage (*3)	V _{dif}	I _{OUT} =45mA	-	120	300	mV	3
		I _{OUT} =90mA	-	380	600		
Supply Current	I _{SS}	V _{IN} =-5.0V	-	3.0	6.5	μA	1
Line Regulation	ΔV _{OUT} ΔV _{IN} · V _{OUT}	I _{OUT} =20mA -5.0V≤V _{IN} ≤-10.0V	-	0.1	0.3	%V	3
Input Voltage	V _{IN}	-	-	-	-10.0	V	-
Output Voltage Temperature Characteristics	ΔV _{OUT} ΔV _{IN} · V _{OUT}	I _{OUT} =20mA -30°C≤T _{opr} ≤80°C	-	±100	-	ppm/ °C	-

NOTE:

*1: V_{OUT(T)}=Specified output voltage

*2: V_{OUT(E)}=Effective output voltage (i.e. the output voltage when "V_{OUT(T)} -1.0V" is provided at the V_{IN} pin while maintaining a certain I_{OUT} value).

*3: V_{dif} = {V_{IN1} - V_{OUT1}}

*4: V_{OUT1} =A voltage equal to 98% of the output voltage whenever an amply stabilized I_{OUT} {V_{OUT(T)} -1.0V} is input.

*5: V_{IN1}=The input voltage when a voltage equal to 98% of V_{OUT(E)} appears. (Input voltage is gradually decreased.)

*6: I_{OUTMAX}=Please ensure that output current is within the values given for power dissipation.

■ ELECTRICAL CHARACTERISTICS (Continued)

XC62KN3002

VOUT(T)=-3.0V

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage (*2)	VOUT(E)	IOUT=20mA VIN=-4.0V	x 0.98 -2.94	VOUT(T) -3.00	x 1.02 -3.06	V	2
MAX. Output Current	IOUT max	VIN=-4.0V, VOUT(E)≥-2.7V	60	-	-	mA	4
Load Regulation	ΔVOUT	VIN=-4.0V 1mA≤IOUT≤40mA	-	40	80	mV	4
Dropout Voltage	Vdif	IOUT=40mA	-	120	300	mV	3
		IOUT=80mA	-	380	600		
Supply Current	I _{SS}	VIN=4.0V	-	2.5	6.0	μA	1
Line Regulation	ΔVOUT ΔVIN · VOUT	IOUT=20mA -4.0V≤VIN≤-10.0V	-	0.1	0.3	%V	3
Input Voltage	VIN	-	-	-	-10.0	V	-
Output Voltage Temperature Characteristics	ΔVOUT ΔVIN · VOUT	IOUT=20mA -30°C≤Topr≤80°C	-	±100	-	ppm/ °C	-

NOTE:

*1: VOUT(T)=Specified output voltage

*2: VOUT(E)=Effective output voltage (i.e. the output voltage when "VOUT(T) -1.0V" is provided at the VIN pin while maintaining a certain IOUT value).

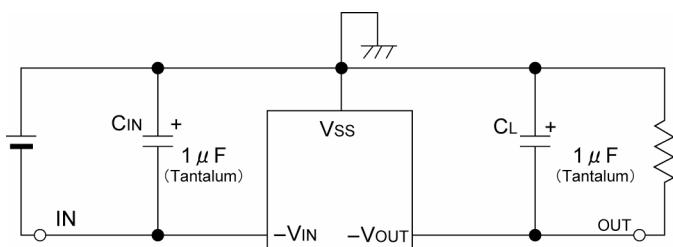
*3: Vdif = {VIN1 - VOUT1}

*4: VOUT1 = A voltage equal to 98% of the output voltage whenever an amply stabilized IOUT {VOUT(T) -1.0V} is input.

*5: VIN1=The input voltage when a voltage equal to 98% of VOUT(E) appears. (Input voltage is gradually decreased.)

*6: IOUTMAX=Please ensure that output current is within the values given for power dissipation.

■ TYPICAL APPLICATION CIRCUIT

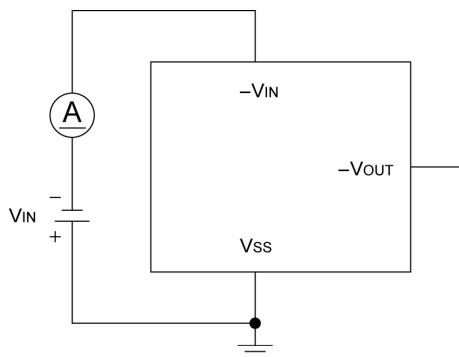


■ NOTES ON USE

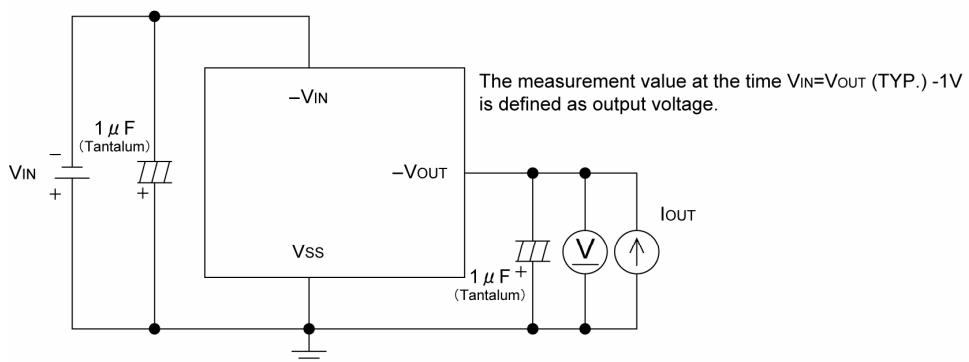
Please ensure that values for input capacitance, C_{IN} and out capacitance, C_L, are more than 1 μF (Tantalum).

■ TEST CIRCUITS

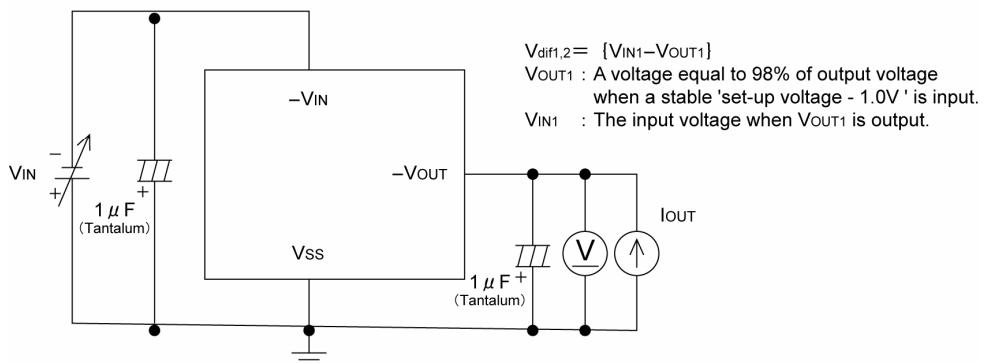
Circuit 1. Supply Current



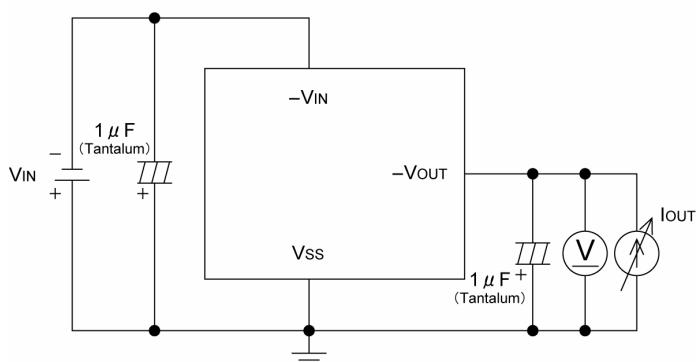
Circuit 2. Output Voltage



Circuit 3. Line Regulation Dropout Voltage

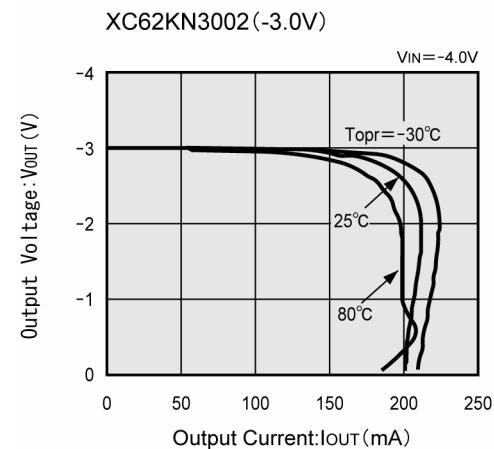
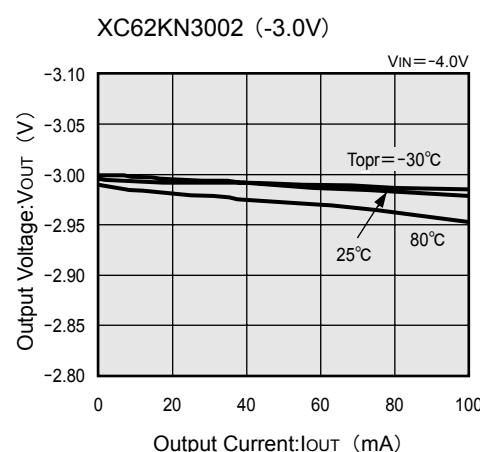
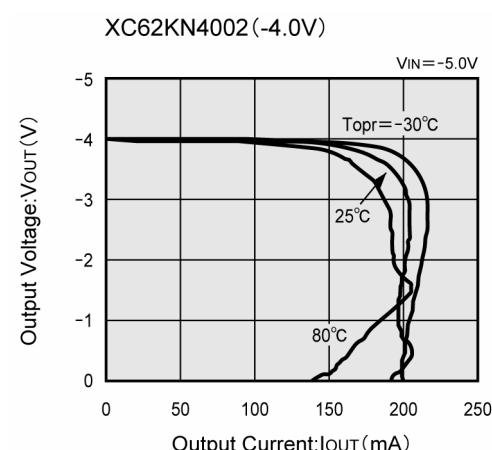
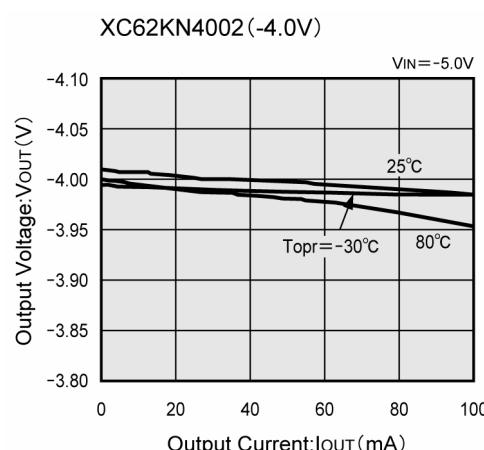
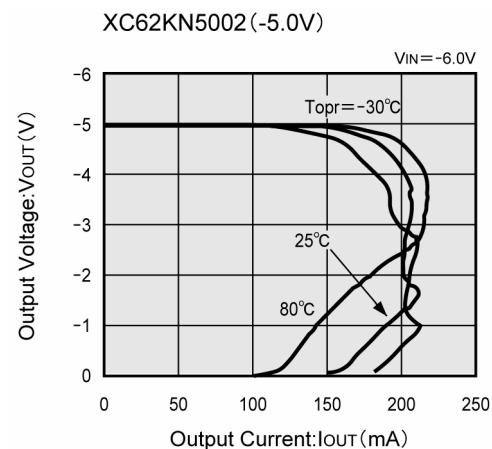
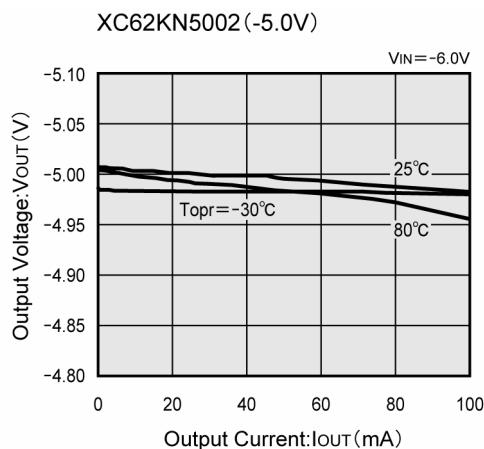


Circuit 4. Load Regulation, Maximum Output Current



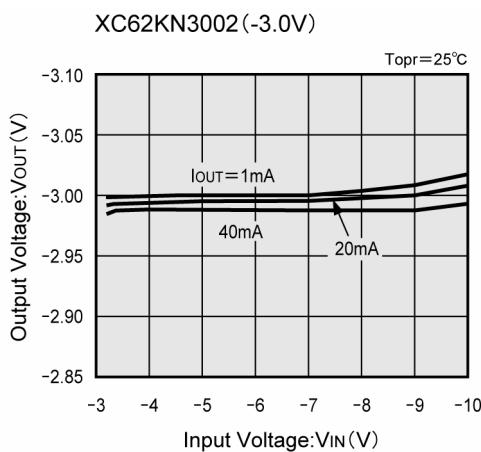
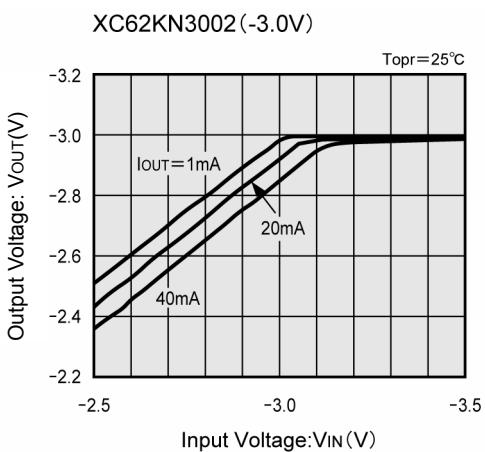
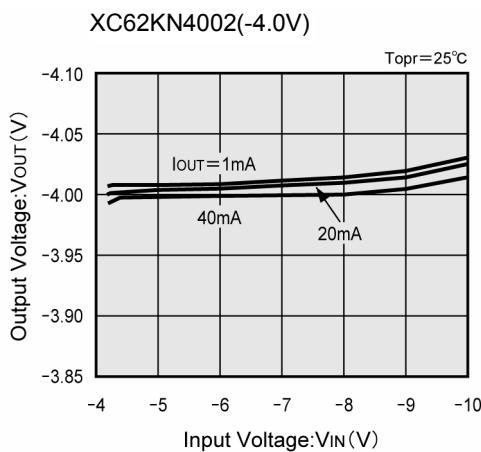
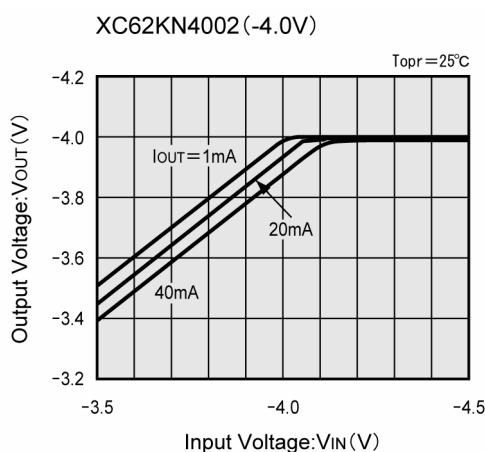
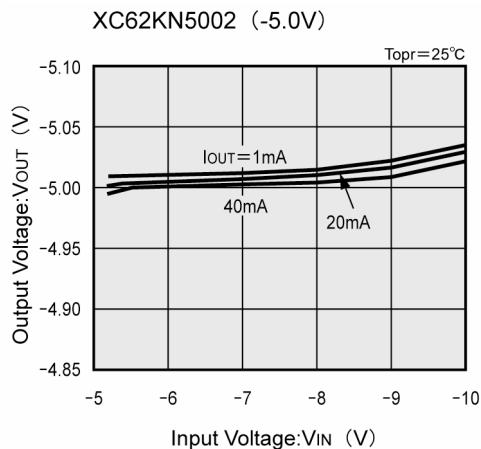
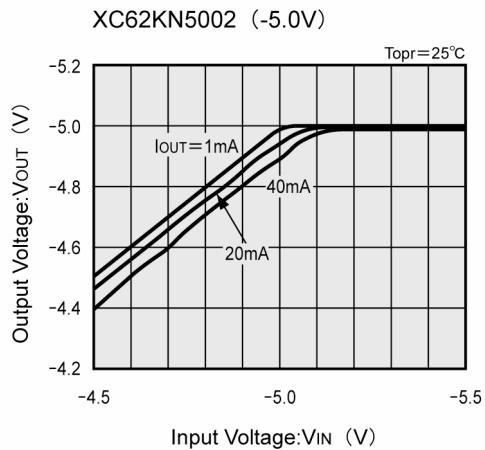
■ TYPICAL PERFORMANCE CHARACTERISTICS

(1) Output Voltage vs. Output Current



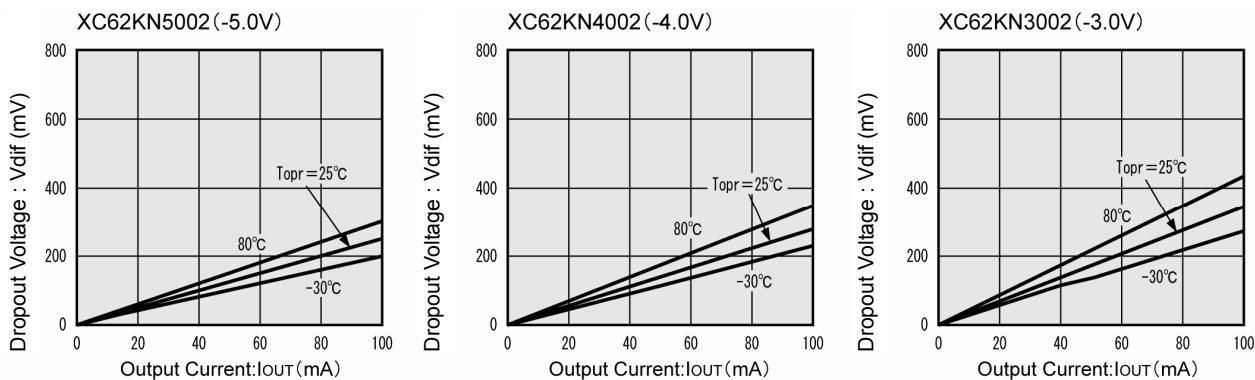
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(2) Output Voltage vs. Input Voltage

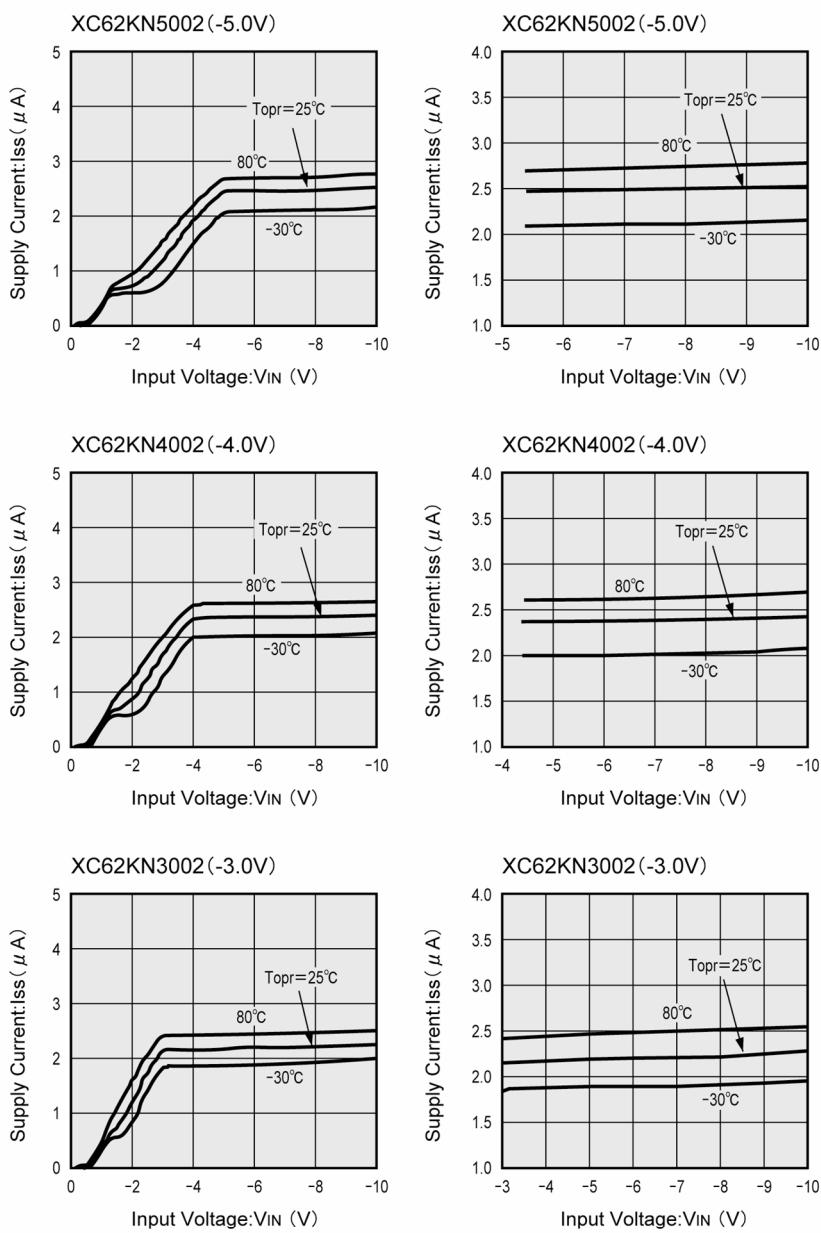


■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(3) Dropout Voltage vs. Output Current

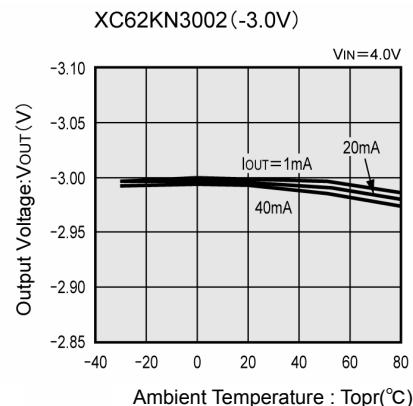
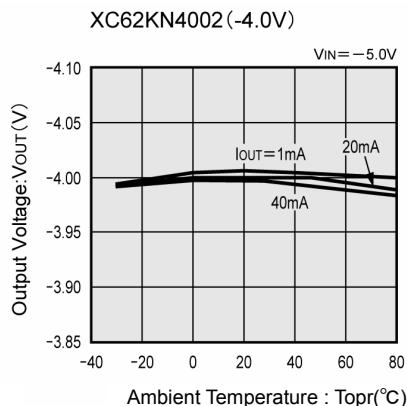
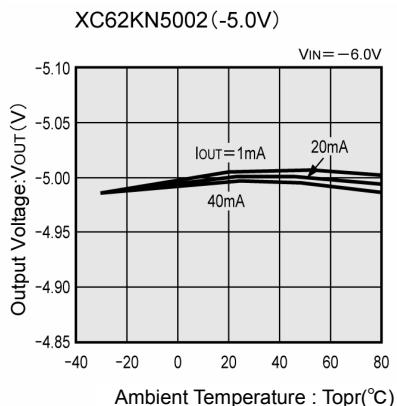


(4) Supply Current vs. Input Voltage

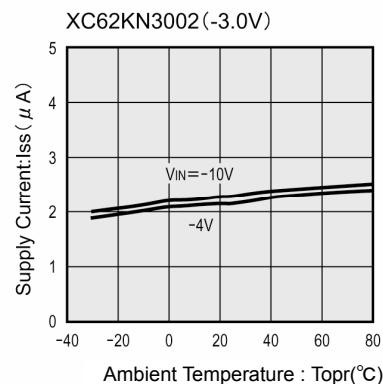
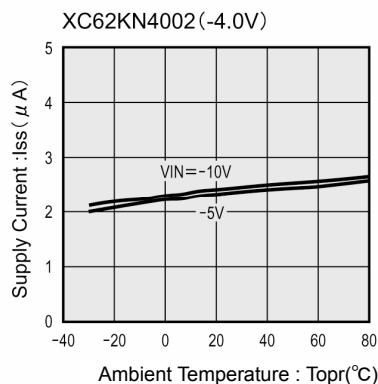
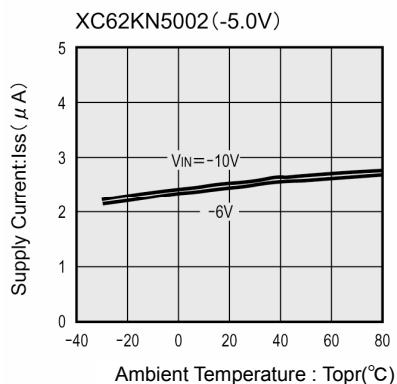


■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

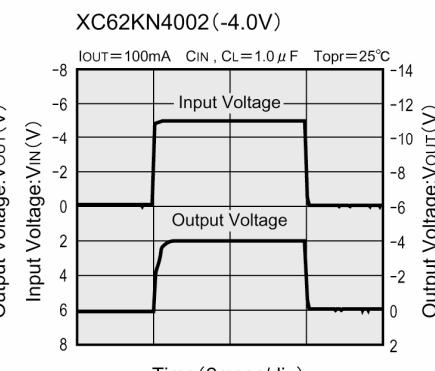
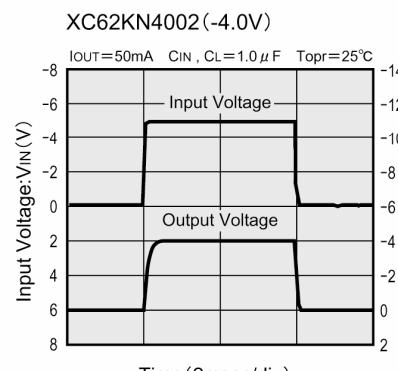
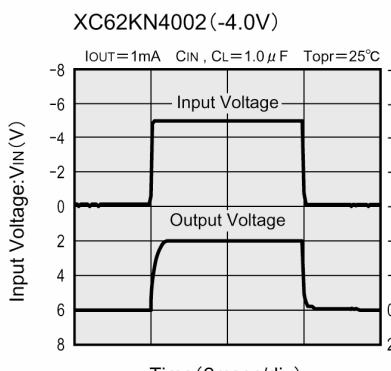
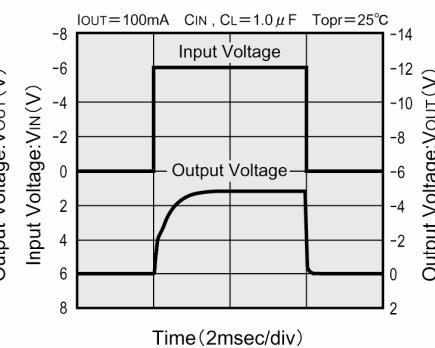
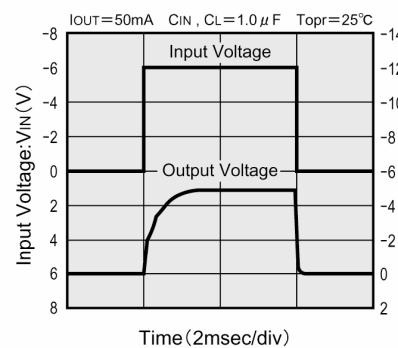
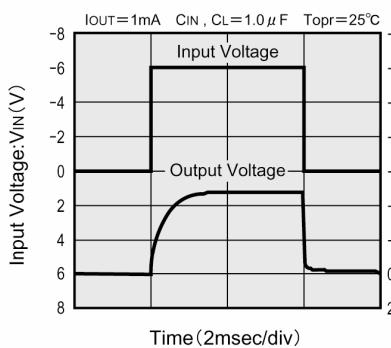
(5) Output Voltage vs. Ambient Temperature



(6) Supply Current vs. Ambient Temperature

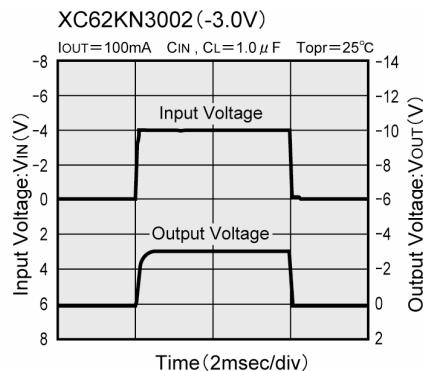
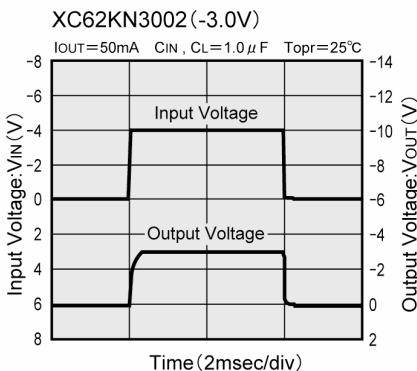
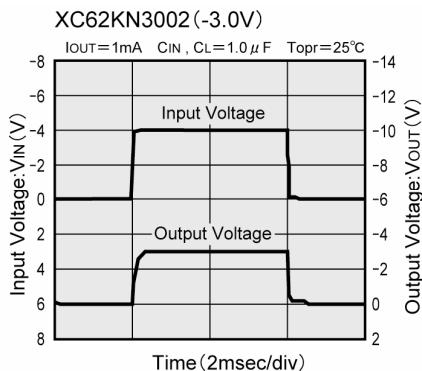


(7) Input Transient Response 1

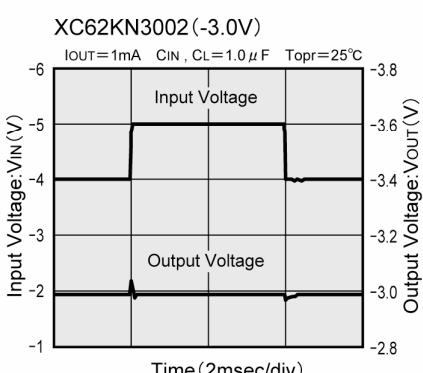
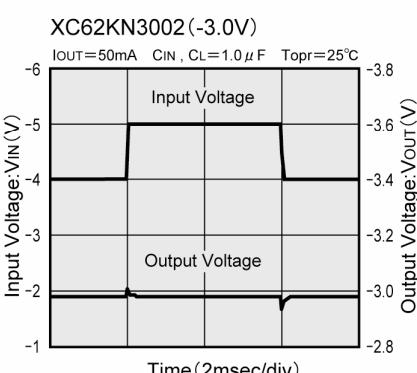
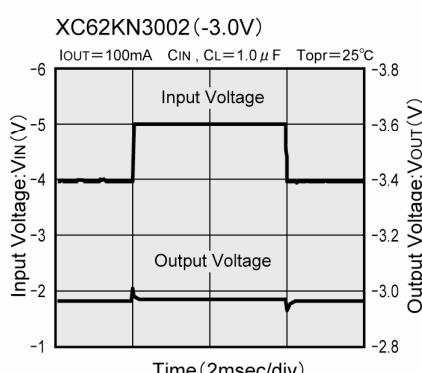
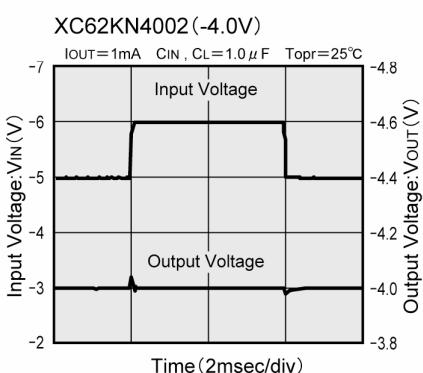
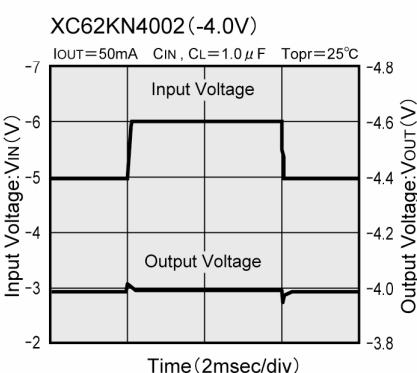
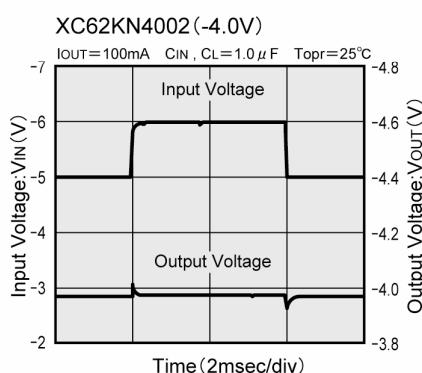
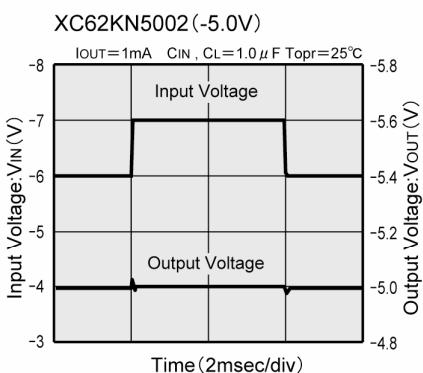
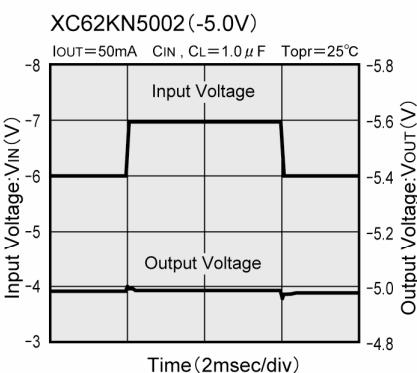
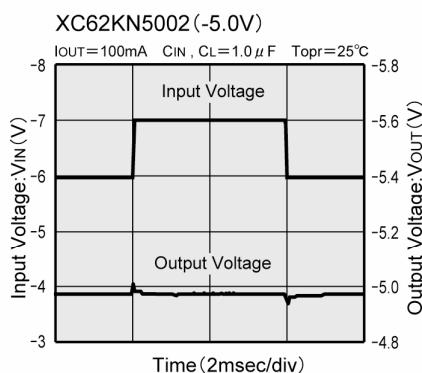


■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(7) Input Transient Response 1

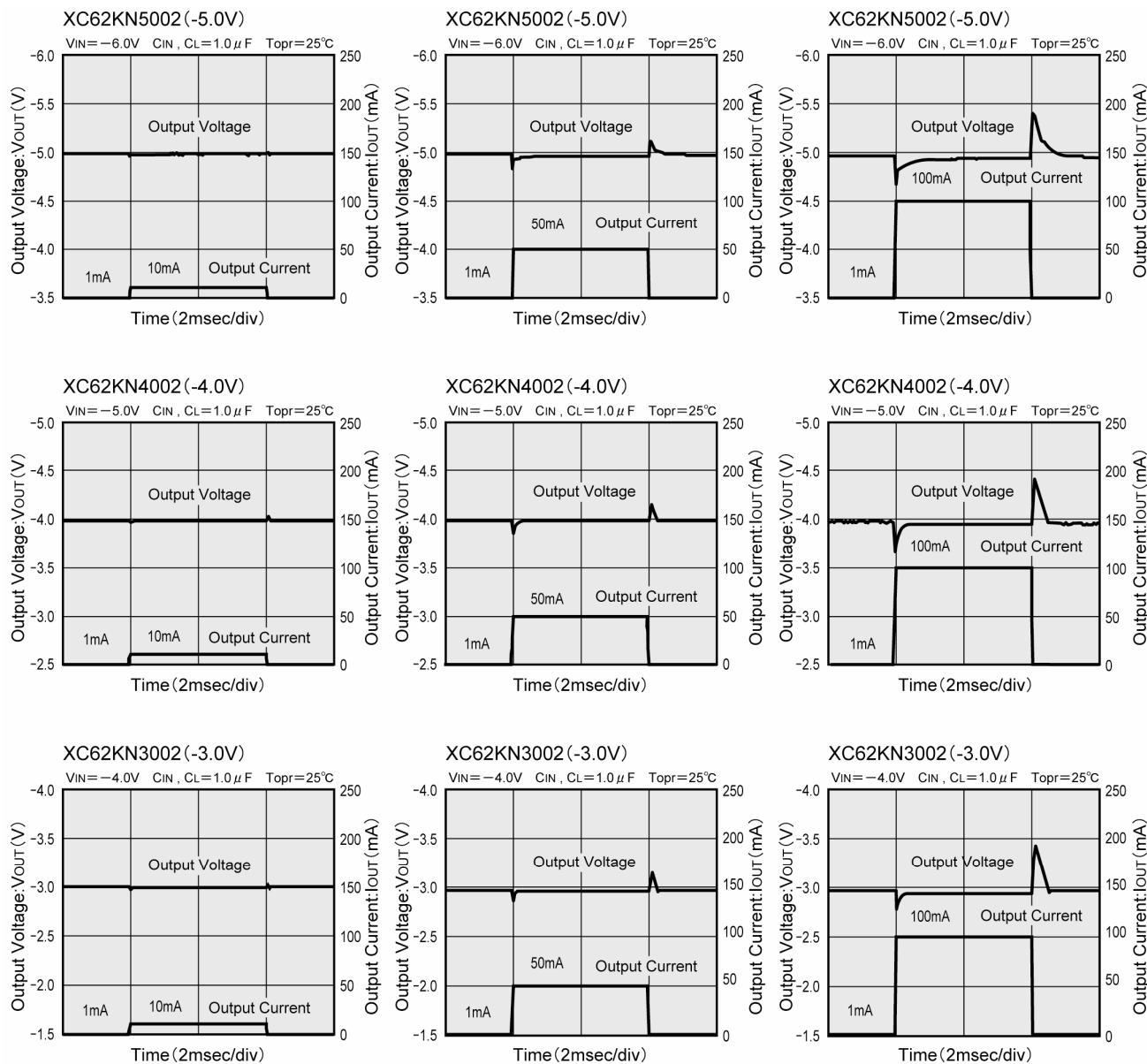


(8) Input Transient Response 2

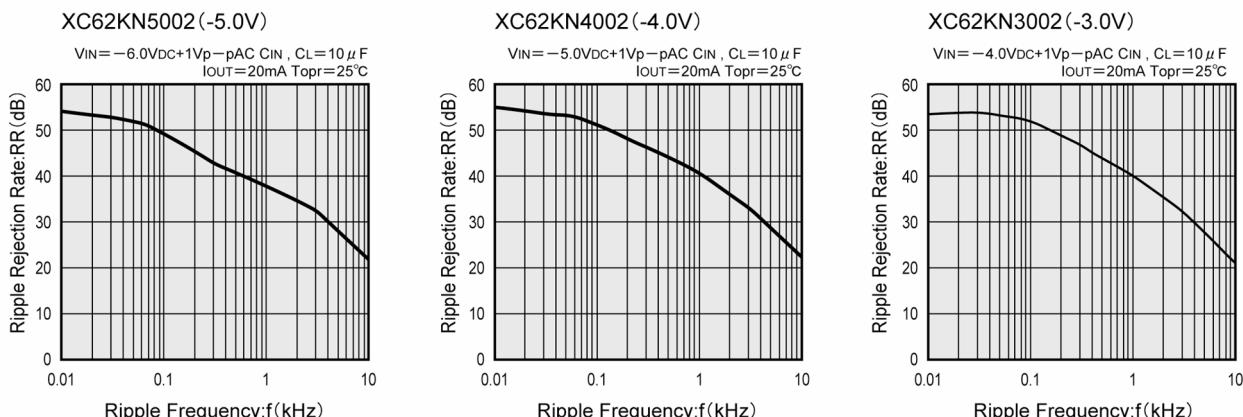


■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) Load Transient Response

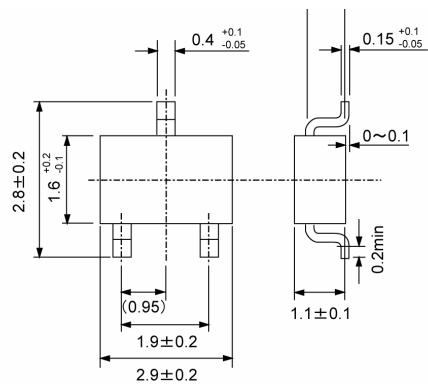


(10) Ripple Rejection Rate

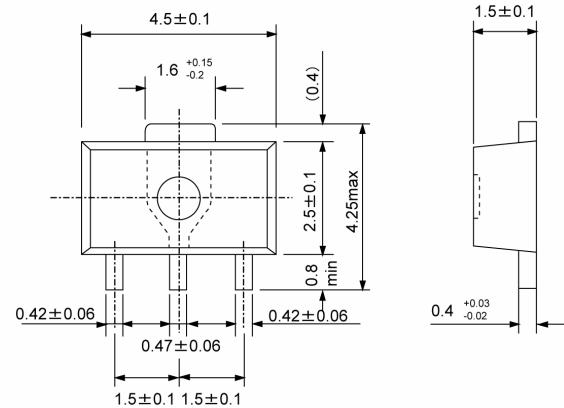


■ PACKAGING INFORMATION

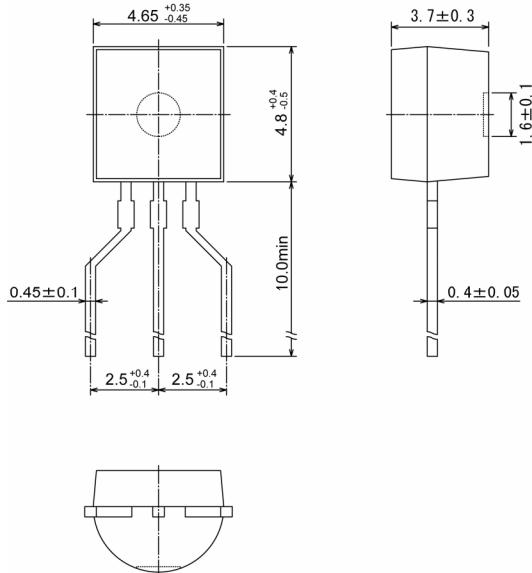
●SOT-23



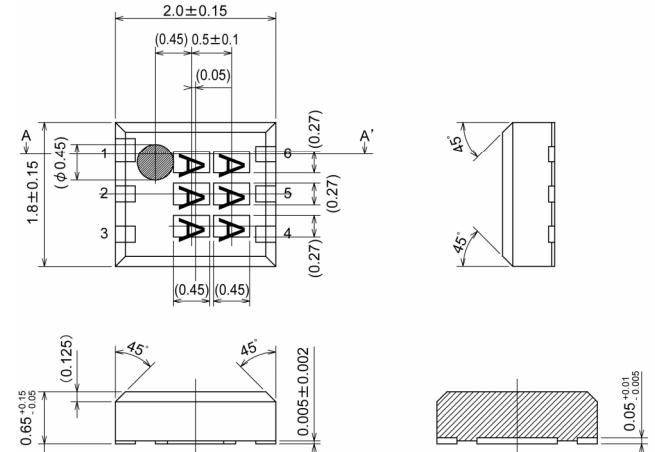
● SOT-89



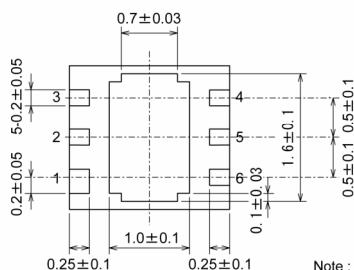
● TO-92



● USP-6B



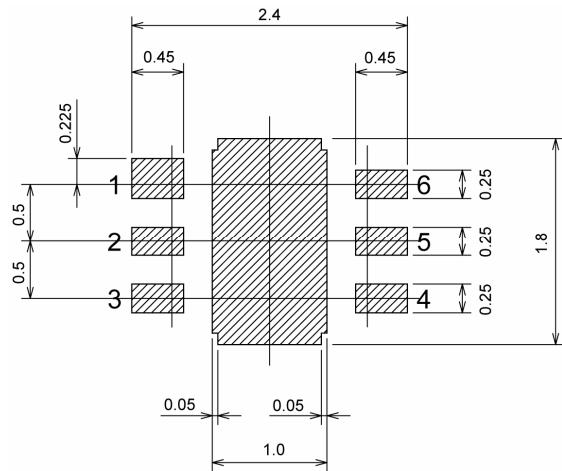
A-A' cross section



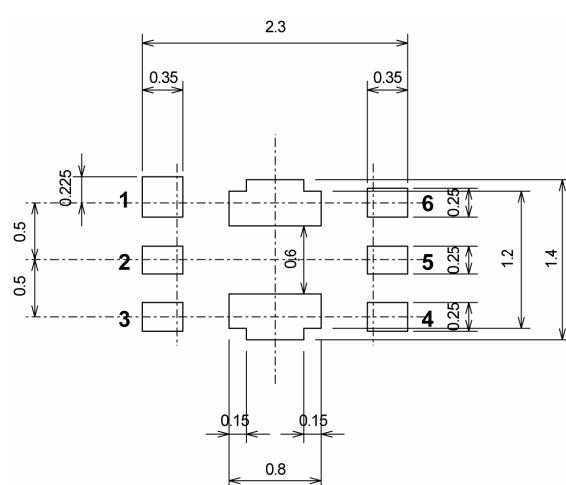
Note : Pin 1 is larger than the other pins.

■PACKAGING INFORMATION (Continued)

●USP-6B Recommended Pattern Layout

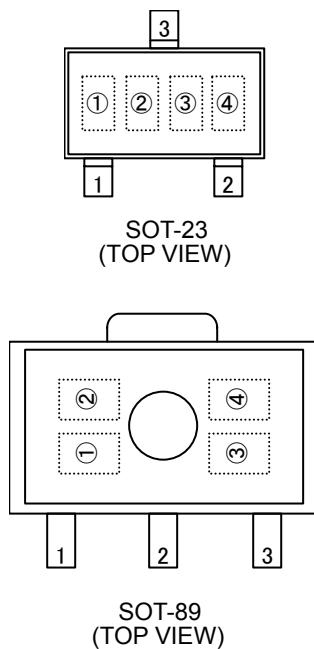


●USP-6B Recommended Metal Mask Design



■ MARKING RULE

●SOT-23, SOT-89



①Represents integral number of output voltage

MARK	VOLTAGE (V)	MARK	VOLTAGE (V)
2	2.X	5	5.X
3	3.X	6	6.X
4	4.X		

②Represents decimal number of output voltage

MARK	VOLTAGE (V)	MARK	VOLTAGE (V)
A	x.0	F	x.5
B	x.1	H	x.6
C	x.2	K	x.7
D	x.3	L	x.8
E	x.4	M	x.9

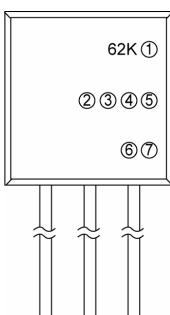
③Represents polarity of output voltage

MARK	POLARITY
5	Negative

④Represents production lot number

0 to 9, A to Z repeated, reverse character 0 to 9, A to Z repeated
(G, I, J, O, Q, W excepted)

●TO-92



TO-92 (T Type)
(TOP VIEW)

①Represents polarity of output voltage

MARK	OUTPUT CONFIGURATION
N	— (Negative)

②③Represents output voltage (ex.)

MARK	VOLTAGE (V)	
	②	③
3	3	3.3
5	0	5.0

④Represents temperature characteristics

MARK	TEMPERATURE CHARACTERISTICS
0	±100 ppm (TYP.)

⑤Represents output voltage accuracy

MARK	OUTPUT VOLTAGE ACCURACY
1	Within ±1% (semi-custom)
2	Within ±2%

⑥Represents least significant digit of production year (ex.)

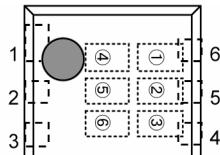
MARK	PRODUCTION YEAR
3	2003
4	2004

⑦Represents production lot number

0 to 9, A to Z repeated (G, I, J, O, Q, W excepted)

■ MARKING RULE (Continued)

●USP-6B



USP-6B
(TOP VIEW)

①Represents production series

MARK	PRODUCT SERIES
K	XC62KNxx0xDx

②Represents polarity of output voltage

MARK	POLARITY	PRODUCT SERIES
N	-(Negative)	XC62KNxx0xDx

③④Represents output voltage (ex.)

MARK		VOLTAGE (V)	PRODUCT SERIES
③	④		
3	3	3.3	XC62KN330xDx
5	0	5.0	XC62KN500xDx

⑤Represents temperature characteristics

MARK	TEMPERATURE CHARACTERISTICS	PRODUCT SERIES
0	± 100 ppm (TYP.)	XC62KNxx0xDx

⑥Represents production lot number

0 to 9, A to Z repeated (G, I, J, O, Q, W excepted)

Note: No character inversion used.

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